

Data sheet acquired from Harris Semiconductor SCHS092C – Revised July 2003

CD4724B Types

CMOS 8-Bit Addressable Latch

High-Voltage Types (20-Volt Rating)

■ CD4724B 8-bit addressable latch is a serial-input, parallel-output storage register that can perform a variety of functions.

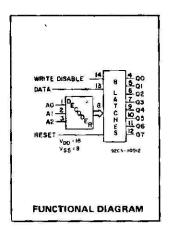
Data are inputted to a particular bit in the latch when that bit is addressed (by-means of inputs A0, A1, A2) and when WRITE DISABLE is at a low level. When WRITE DISABLE is high, data entry is inhibited; however, all 8 outputs can be continuously read independent of WRITE DISABLE and address inputs.

A master RESET input is available, which resets all bits to a logic "0" level when RESET and WRITE DISABLE are at a high level. When RESET is at a high level, and WRITE DISABLE is at a low level, the latch acts as a 1-of-8 demultiplexer; the bit that is addressed has an active output which follows the data input, while all unaddressed bits are held to a logic "0" level.

The CD4724B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (NSR suffix), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

Feature

- Safial date input Active parallel output
- Storage register capability Master clear
- Can function as demultiplexer
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 µA at 18 V (full package-temperature range), 100 nA at 18 V and 25°C.
- Noise margin (full package-temperature rarige) = 1 V at VDD = 5 V, 2 V at VDD = 10 V, 2.5 V at VDD = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"



Applications:

- Multi-line decoders
- A/D converters

| MAXIMUM RATINGS, Absolute-Maximum Values: |
|---|
| DC SUPPLY-VOLTAGE RANGE, (VDD) |
| Voltages referenced to Voe Terminal) |
| NEIDLT WOLFAGE RANGE ALL INPUTS |
| DC INPUT CURRENT, ANY ONE INPUT ±10mA |
| DOWNED DISCUSSION PER PACKAGE (PD): |
| The Target of A MARCO |
| For TA = +10900 to ±1250C Derate Linearity at 12mW/°C to 200mW |
| DEVICE DISCIPATION FOR CUITPUT TRANSISTOR |
| FOR THE PACKAGE-TEMPERATURE RANGE (All Package Types): 100mV |
| OBEDIATED TELABEDATIBE RANGE (TA) |
| STORAGE TEMPERATURE RANGE (Tsig)65°C to +150°C |
| LEAD TEMPERATURE (DURING SOLDERING): |
| Ardistance 1/16 ± 1/32 inch (1.59 ± 0.79mm) from case for 10s max+265°C |

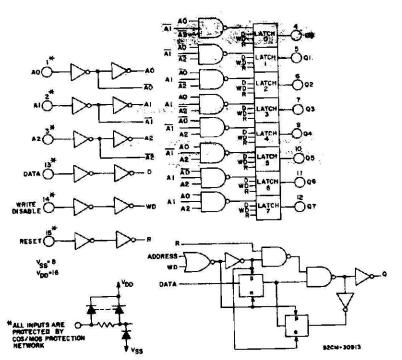
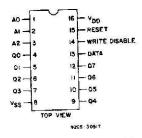


Fig. 1- Logic diagram of CD47248 and detail of 1 of 8 latches.



TERMINAL ASSIGNMENT

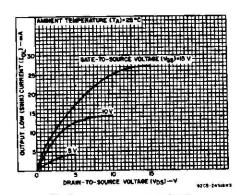


Fig. 2— Typical output low (sink) current characteristics.

RECOMMENDED OPERATING CONDITIONS at $T_A \approx 25^{\circ}$ C (Unless otherwise specified) For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

| CHARACTERISTIC | SEE | V _{DD} | LIM | UNITS | | |
|--|----------|-----------------|------|-------|-------|--|
| | FIG. 15* | (V) | MIN. | MAX. | ONIIS | |
| Supply Voltage Range: {At T _A = Full Package Temperature Range) | | | 3 | 18 | ٧ | |
| Pulse Width, tw | | 5 | 200 | _ | | |
| Data | (4) | 10 | 100 | _ | | |
| | | 15 | 80 | | | |
| | | 5 | 400 | - | ns | |
| Address | 8 | 10 | 200 | - | , ris | |
| | | 15 | 126 | _ | | |
| | | 5 | 150 | _ | | |
| Reset | (5) | 10 | 75 | _ | | |
| | | 15 | 50 | | L | |
| Setup Time, t _S | | 5 | 100 | _ | | |
| Data to WRITE DISABLE | (8) | 10 | 50 | | | |
| | | 15 | 35 | _ | ns | |
| Hold Time, t _H | | 5 | 150 | | | |
| Data to WRITE DISABLE | (7) | 10 | 75 | | ns | |
| | | 15 | 60 | _ | [| |

^{*} Circled numbers refer to times indicated on master timing diagram.

Note: In addition to the above characteristics, a WRITE DISABLE ON time (the time that WRITE DISABLE is at a high level) must be observed during an address change for the total time that the external address lines A0, A1, and A2 are settling to a stable level, to prevent a wrong cell from being addressed.

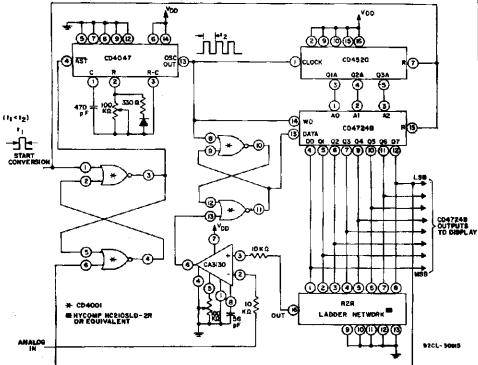
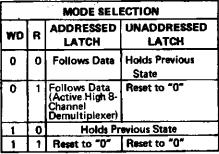


Fig. 5- A/D converter



WD - WRITE DISABLE

R = RESET

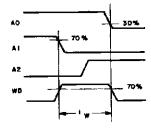


Fig. 3— Definition of WRITE DISABLE ON time.

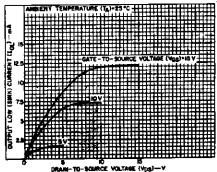


Fig. 4— Minimum output low (sink) current characteristics.

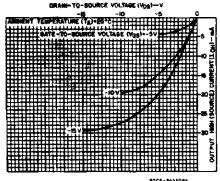
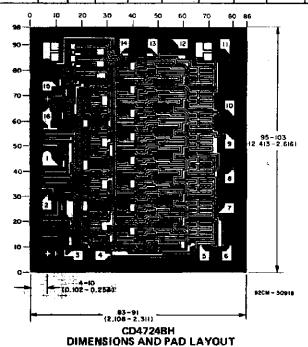


Fig.5 - Typical output high (source) current characteristics.

STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER- | COND | NOITION | 25 | LIMITS AT INDICATED TEMPERATURES (°C) | | | | | | | UNITS |
|---|----------|---------|-----|---------------------------------------|-------|-------|-------|-------------------|----------|------|-------|
| ISTIC | ٧o | VIN | ۷pp | | | | | | DMI12 | | |
| | (V). | (V) | (V) | –5 5 | -40 | +85 | +125 | Min. | Тур. | Max. | |
| Quiescent Device | - | 0,5 | 5 | 5 | 5 | 150 | 150 | 1 | 0.04 | 5 | μA |
| Current, | | 0,10 | 10 | 10 | 10 | 300 | 300 | - | 0.04 | 10 | |
| IDD Max. | | 0,15 | 15 | 20 | 20 | 600 | 600 | _ | 0.04 | 20 | μΑ |
| | _ | 0,20 | 20 | 100 | 100 | 3000 | 3000 | | 0.08 | 100 | |
| Output Low | 0.4 | 0,5 | 5 | 0.64 | 0.61 | 0.42 | 0.36 | 0.51 | . 1 | | |
| (Sink) Current IOL Min. | 0.5 | 0,10 | 10 | 1.6 | 1.5 | 1.1 | 0.9 | 1.3 | 2.6 | | |
| | 1.5 | 0,15 | 15 | 4.2 | 4 | 2.8 | 2.4 | 34 | 6.8 | - | |
| Output High (Source) Current, IOH Min. | 4.6 | 0,5 | 5 | -0.64 | -0.61 | -0.42 | -0.36 | -0.51 | -1 | - | mA |
| | 2,5 | 0,5 | 5 | -2 | -1.8 | -1.3 | -1.15 | -1.6 | 3.2 | - | |
| | 9.5 | 0,10 | 10 | -1.6 | -1.5 | -1.1 | -0.9 | -1.3 | -2.6 | . – | |
| | 13.5 | 0,15 | 15 | -4.2 | -4 | -2.8 | -2.4 | -3.4 | -6.8 | - | |
| Output Voltage: Low-Level, VOL Max. | _ | 0,5 | 5 | | 0 | .05 | | - | 0 | 0.05 | v |
| | | 0,10 | 10 | | 0 | .05 | • | | 0 | 0.05 | |
| | _ | 0,15 | 15 | | 0 | .05 | | | 0 | 0.05 | |
| Output Voltage: High-Level, VOH Min. | - | 0,5 | 5 | | 4 | .96 | | 4.95 | 5 | _ | |
| | _ | 0,10 | 10 | | 9 | .95 | | 9.95 | 10 | - | |
| | - | 0,15 | 15 | | 14 | 1.95 | | 14.95 | 15 | _ | |
| Input Low Voltage, VIL Max. | 0.5, 4.5 | - | 5 | | 1 | 1.5 | | _ | <u> </u> | 1.5 | |
| | 1, 9 | - | 10 | | | 3 | | - | | 3 | |
| | 1.5,13.5 | - | 15 | | | 4 | | 1 | _ | 4 | v |
| Input High Voltage, VIH Min. | 0.5, 4.5 | - | 5 | 3.5 3.5 | | | | <u> </u> | |] | |
| | 1, 9 | 1 | 10 | | | 7 | | 7 | Ī — | |] |
| | 1.5,13.5 | 1 | 15 | . 11 | | | | 11 | - | _ | |
| Input Current IJN Max. | - | 0,18 | 18 | ±0.1 ±0.1 ±1 ±1 | | | _ | ±10 ⁻⁵ | ±0.1 | μА | |



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).

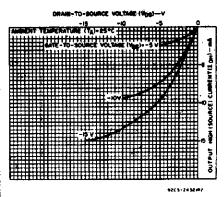


Fig.7 - Minimum output high (source) current characteristics.

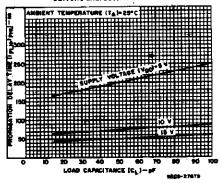


Fig. 8 — Typical propagation delay time (data to On) vs. load capacitance.

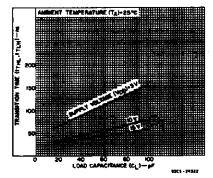


Fig. 9 — Typical transition time vs. load capacitance.

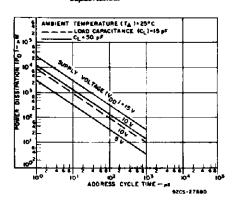


Fig. 10 — Typical dynamic power dissipation vs. address cycle time.

DYNAMIC ELECTRICAL CHARACTERISTICS at T_A = 25° C, C_L = 50 pF, input t_P , t_F = 20 ns, R_L = 200 K Ω

| | CONDI | | LIN ALL PACE | UNITS | | |
|-----------------------------------|-------------------|-----|-----------------|-------|------|--|
| CHARACTERISTIC | \$EE Fig. 15* | VDD | <u> </u> | | | |
| | Fig. 15* | (V) | TYP, | MAX. | | |
| Propagation Delay: tpLH. | | 5 | 200 | 400 | | |
| †PHL | $\mid \odot \mid$ | 10 | 75 | 150 | | |
| Data to Output, | | 15 | 50 | 100 | | |
| WRITE DISABLE | | 5 | 200 | 400 | | |
| to Output, _{tPLH} , | ② | 10 | 80 | 160 | пs | |
| tPHL | | 15 | 60 | 120 | | |
| | | 5 | 175 | 350 | | |
| Reset to Output, | ③ | 10 | 80 | 160 | | |
| tphl | | 15 | 65 | 130 | | |
| Address to Output, | | 5 | 225 | 450 | | |
| ^t PLH | 1 1 1 | 10 | 100 | 200 | | |
| [†] PHL | | 15 | 75 | 150 | | |
| Transition Time, t _{THL} | 1 | 5 | 100 | 200 | | |
| (Any Output) t _{TLH} | | 10 | 50 | 100 | ns | |
| | | 15 | 40 | 80 | | |
| Minimum Pulse | | 5 | 100 | 200 | | |
| Width, tw | 4 | 10 | 50 | 100 | ns | |
| Data | | 15 | 40 | 80 | | |
| | | 5 | 200 | 400 | | |
| Address | 8 | 10 | 100 | 200 | nis. | |
| | | 15 | 65 | 125 | | |
| | | 5 | 75 | 150 | | |
| Reset | 5 | 10 | 40 | 75 | ns | |
| | | 15 | 25 | 50 | | |
| Minimum Setup | | 5 | 50 | 100 | | |
| Time, t _S | 6 | 10 | 25 | 50 | ns | |
| Data to WRITE DISABLE | - | 15 | 20 | 35 | | |
| Minimum Hold | | 5 | 75 | 150 | | |
| Time, t _H | 101 | 10 | 40 | 75 | an | |
| Data to WRITE DISABLE | | 15 | 25 | 50 | | |
| Input Capacitance, CIN | Any Inc | out | 5 | 7.5 | ρF | |

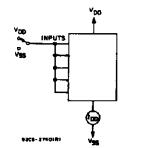


Fig. 11— Quiescent device current test circuit.

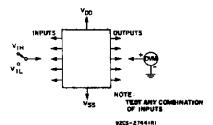


Fig. 12- Input valtage test circuit.

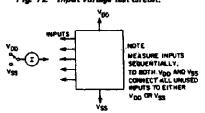
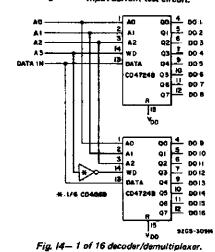
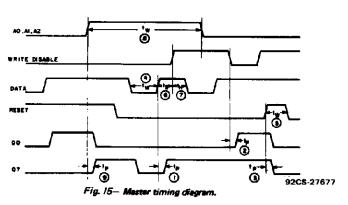


Fig. 13- Input current test circuit.

9265-27402



*Circled numbers refer to times indicated on master timing diagram.



DATA

CD47248

CD4724

Fig I6— Multiple selection decoding — 4 x 4 crosspoint switch.



PACKAGE OPTION ADDENDUM

4-Feb-2021

PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | Eco Plan | Lead finish/ Ball material (6) | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|--------------------|--------------|----------------------|---------|
| CD4724BE | ACTIVE | PDIP | N | 16 | 25 | RoHS & Green | NIPDAU | N / A for Pkg Type | -55 to 125 | CD4724BE | Samples |
| CD4724BF3A | ACTIVE | CDIP | J | 16 | 1 | Non-RoHS & Green | SNPB | N / A for Pkg Type | -55 to 125 | CD4724BF3A | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

4-Feb-2021

OTHER QUALIFIED VERSIONS OF CD4724B, CD4724B-MIL:

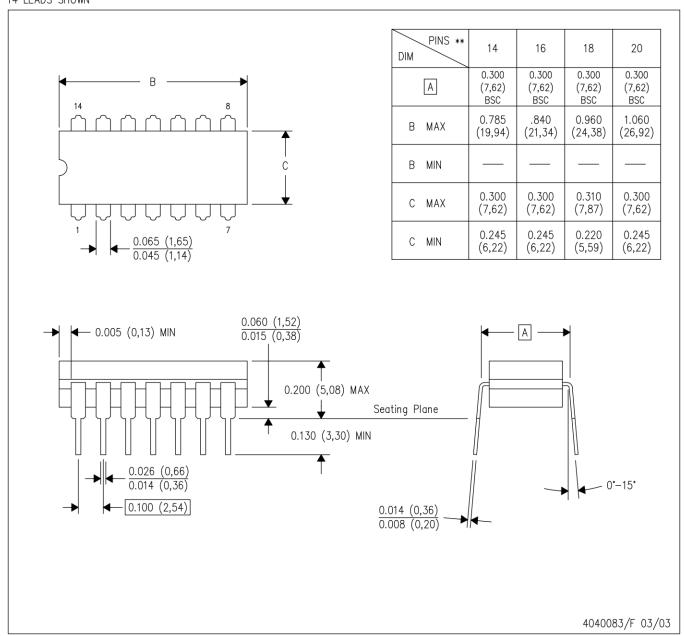
• Catalog: CD4724B

• Military: CD4724B-MIL

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

14 LEADS SHOWN



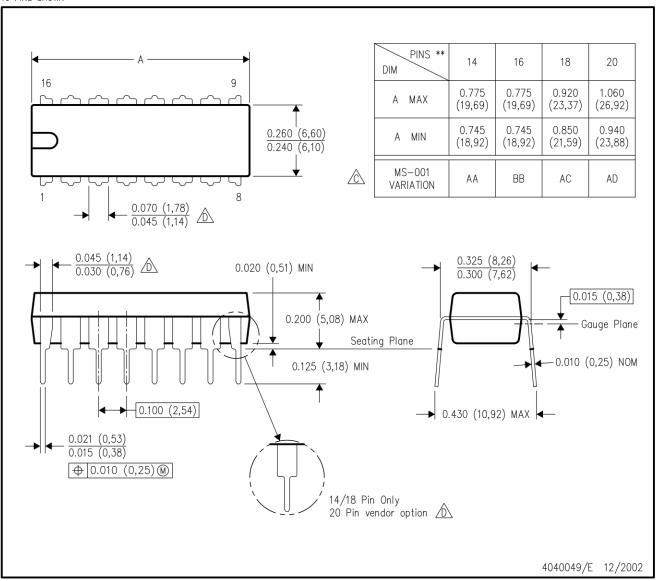
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



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